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November 2013

FCH76N60N

N-Channel SupreMOS[®] MOSFET 600 V, 76 A, 36 m Ω

Features

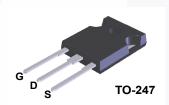
- $R_{DS(on)}$ = 28 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 38 A
- Ultra Low Gate Charge (Typ. Q_q = 218 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 914 pF)
- · 100% Avalanche Tested
- · RoHS Compliant

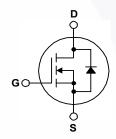
Application

- · Solar Inverter
- AC-DC Power Supply

Description

The SupreMOS® MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | Parameter | | FCH76N60N | Unit |
|-----------------------------------|---|---|-------------|-------|
| V _{DSS} | Drain to Source Voltage | | 600 | V |
| V _{GSS} | Gate to Source Voltage | | ±30 | V |
| | Drain Current | - Continuous (T _C = 25°C) | 76 | Α |
| ID | Drain Current | - Continuous (T _C = 100°C) | 48.1 | A |
| I _{DM} | Drain Current | - Pulsed (Note 1 |) 228 | Α |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | 2) 8022 | mJ |
| I _{AR} | Avalanche Current (Note 1) | |) 25.3 | Α |
| E _{AR} | Repetitive Avalanche Energy (Note 1) | | 5.43 | mJ |
| dv/dt | MOSFET dv/dt | | 100 | V/ns |
| av/at | Peak Diode Recovery dv/dt | (Note 3 | 3) 20 | V/IIS |
| D | Dower Discipation | $(T_C = 25^{\circ}C)$ | 543 | W |
| P_{D} | Power Dissipation | - Derate above 25°C | 4.34 | W/°C |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +150 | °C |
| TL | Maximum Lead Temperature for | Soldering, 1/8" from Case for 5 Seconds | 300 | °C |

^{*}Drain current limited by maximum junction temperature

Thermal Characteristics

| Symbol | Parameter | FCH76N60N | Unit |
|-----------------|--|-----------|-------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 0.23 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. 40 | | -C/VV |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|-----------|---------|----------------|-----------|------------|----------|
| FCH76N60N | FCH76N60N | TO-247 | Tube | N/A | N/A | 30 units |

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|---|--|---|------|------|------|-------|
| Off Charac | cteristics | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V, T_C = 25^{\circ} C$ | 600 | - | - | V |
| ΔBV _{DSS} / ΔT _J | Breakdown Voltage Temperature Coefficient | I_D = 250 μ A, Referenced to 25°C | - | 0.73 | - | V/°C |
| 1 | Zero Gate Voltage Drain Current | V _{DS} = 480 V, V _{GS} = 0 V | - | - | 10 | ^ |
| DSS | Zero Gate voltage Drain Current | $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$ | - | - | 100 | μА |
| I _{GSS} | Gate to Body Leakage Current | V _{GS} = ±30 V, V _{DS} = 0 V | - | - | ±100 | nA |

On Characteristics

| V _{GS(th)} | Gate Threshold Voltage | $V_{GS} = V_{DS}, I_{D} = 250 \mu\text{A}$ | 2.0 | - | 4.0 | V |
|---------------------|--------------------------------------|---|-----|----|-----|-----------|
| R _{DS(on)} | Static Drain to Source On Resistance | V _{GS} = 10 V, I _D = 38 A | - | 28 | 36 | $m\Omega$ |
| 9 _{FS} | Forward Transconductance | V _{DS} = 20 V, I _D = 38 A | - | 90 | - | S |

Dynamic Characteristics

| C _{iss} | Input Capacitance | V _{DS} = 100 V, V _{GS} = 0V f = 1 MHz | | 9310 | 12385 | pF |
|------------------------|-----------------------------------|--|-----|------|-------|----|
| C _{oss} | Output Capacitance | | | 370 | 495 | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 3.1 | 5 | pF |
| C _{oss} | Output Capacitance | V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz | - \ | 195 | - | pF |
| C _{oss(eff.)} | Effective Output Capacitance | V _{DS} = 0 V to 380 V, V _{GS} = 0 V | - | 914 | - | pF |
| Q _{g(tot)} | Total Gate Charge at 10V | V _{DS} = 380 V, I _D = 38 A, | - | 218 | 285 | nC |
| Q _{gs} | Gate to Source Gate Charge | V _{GS} = 10 V | - | 39 | - | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | (Note 4) | - | 66 | - | nC |
| ESR | Equivalent Series Resistance(G-S) | f = 1 MHz | - | 1.0 | - | Ω |

Switching Characteristics

| t _{d(on)} | Turn-On Delay Time | | - | 34 | 78 | ns |
|---------------------|---------------------|---|----|-----|-----|----|
| t _r | | $V_{DD} = 380 \text{ V}, I_D = 38 \text{ A},$ | -/ | 24 | 58 | ns |
| t _{d(off)} | Turn-Off Delay Time | $R_G = 25 \Omega$ | - | 235 | 480 | ns |
| t _f | Turn-Off Fall Time | (Note 4) | - | 32 | 74 | ns |

Drain-Source Diode Characteristics

| I _S | Maximum Continuous Drain to Source Diode Forward Current | | | - | 76 | Α |
|-----------------|--|--|---|-----|-----|----|
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | - | - | 228 | Α |
| V_{SD} | Drain to Source Diode Forward Voltage | V _{GS} = 0 V, I _{SD} = 38 A | - | - | 1.2 | V |
| t _{rr} | Reverse Recovery Time | V _{GS} = 0 V, I _{SD} = 38 A, | - | 612 | - | ns |
| Q _{rr} | Reverse Recovery Charge | $dI_F/dt = 100 A/\mu s$ | - | 16 | - | μС |

Notes:

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. I $_{AS}$ = 25.3 A, R $_{G}$ = 25 Ω , starting T $_{J}$ = 25°C.
- 3. I $_{SD} \leq 76$ A, di/dt ≤ 200 A/µs, V $_{DD} \leq 380$ V, starting T $_{J}$ = 25°C.
- 4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

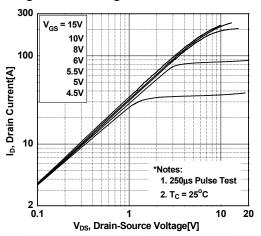


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

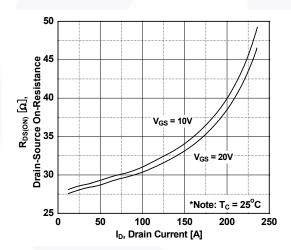


Figure 5. Capacitance Characteristics

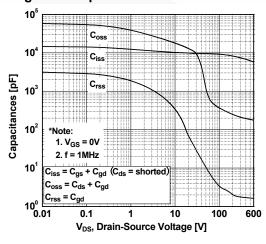


Figure 2. Transfer Characteristics

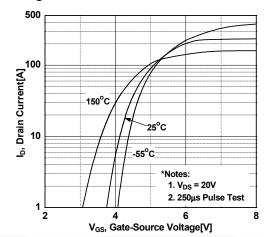


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

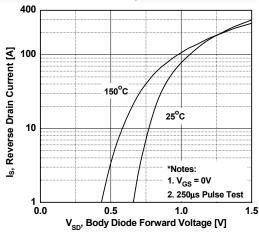
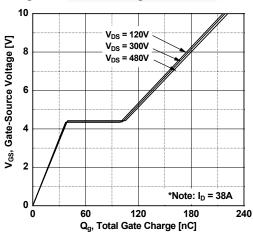


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

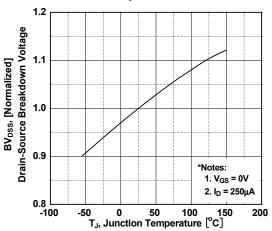


Figure 8. On-Resistance Variation vs. Temperature

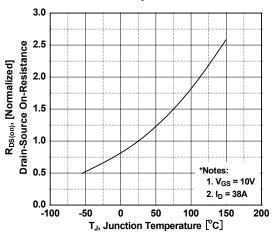


Figure 9. Maximum Safe Operating Area

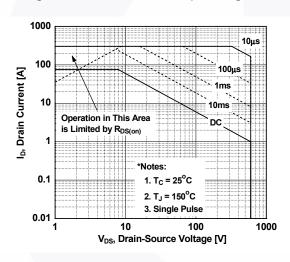


Figure 10. Maximum Drain Current vs. Case Temperature

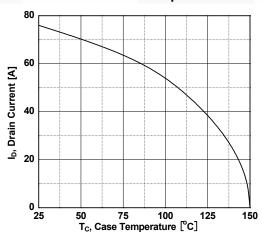
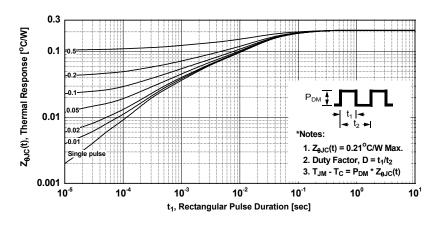


Figure 11. Transient Thermal Response Curve



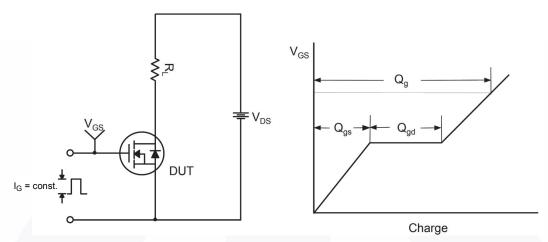


Figure 12. Gate Charge Test Circuit & Waveform



Figure 13. Resistive Switching Test Circuit & Waveforms



Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

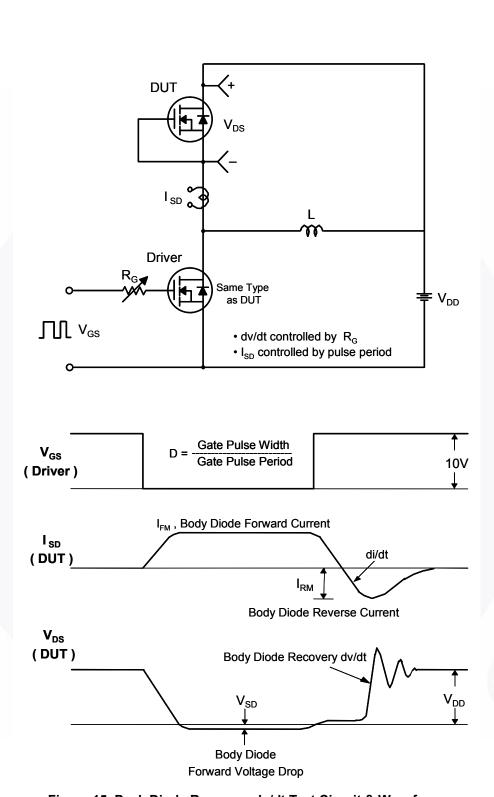
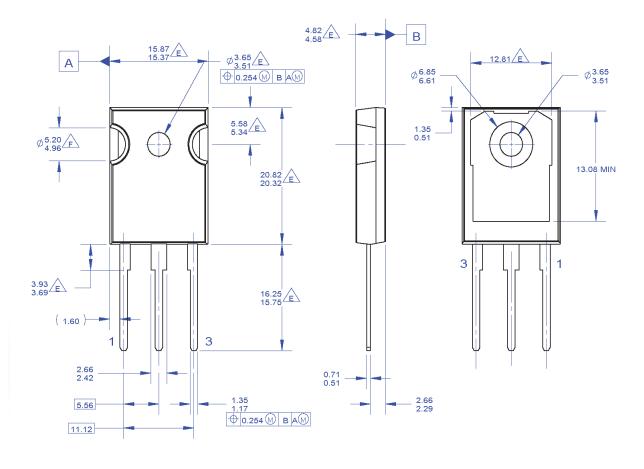


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions



NOTES: UNLESS OTHERWISE SPECIFIED

- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE E, VARIATION AB, DATED JUNE, 2004.
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- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DRAWING CONFORMS TO ASME Y14.5 1994

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G. DRAWING FILENAME: MKT-TO247A03_REV03

Figure 16. TO-247, Molded, 3-Lead, Jedec Variation AB

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